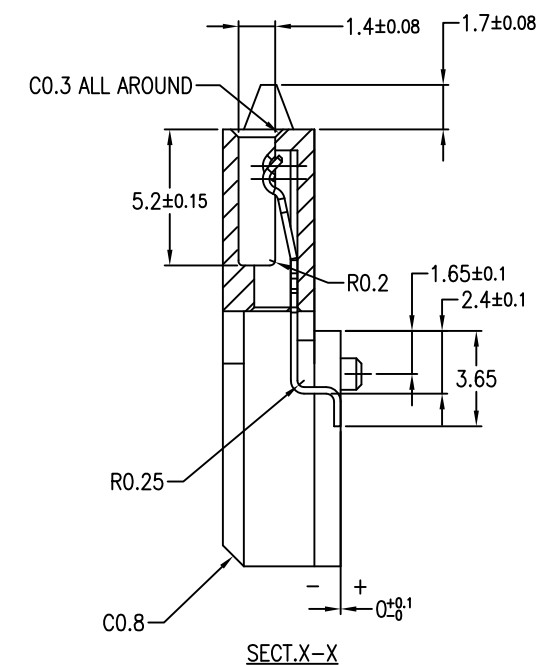
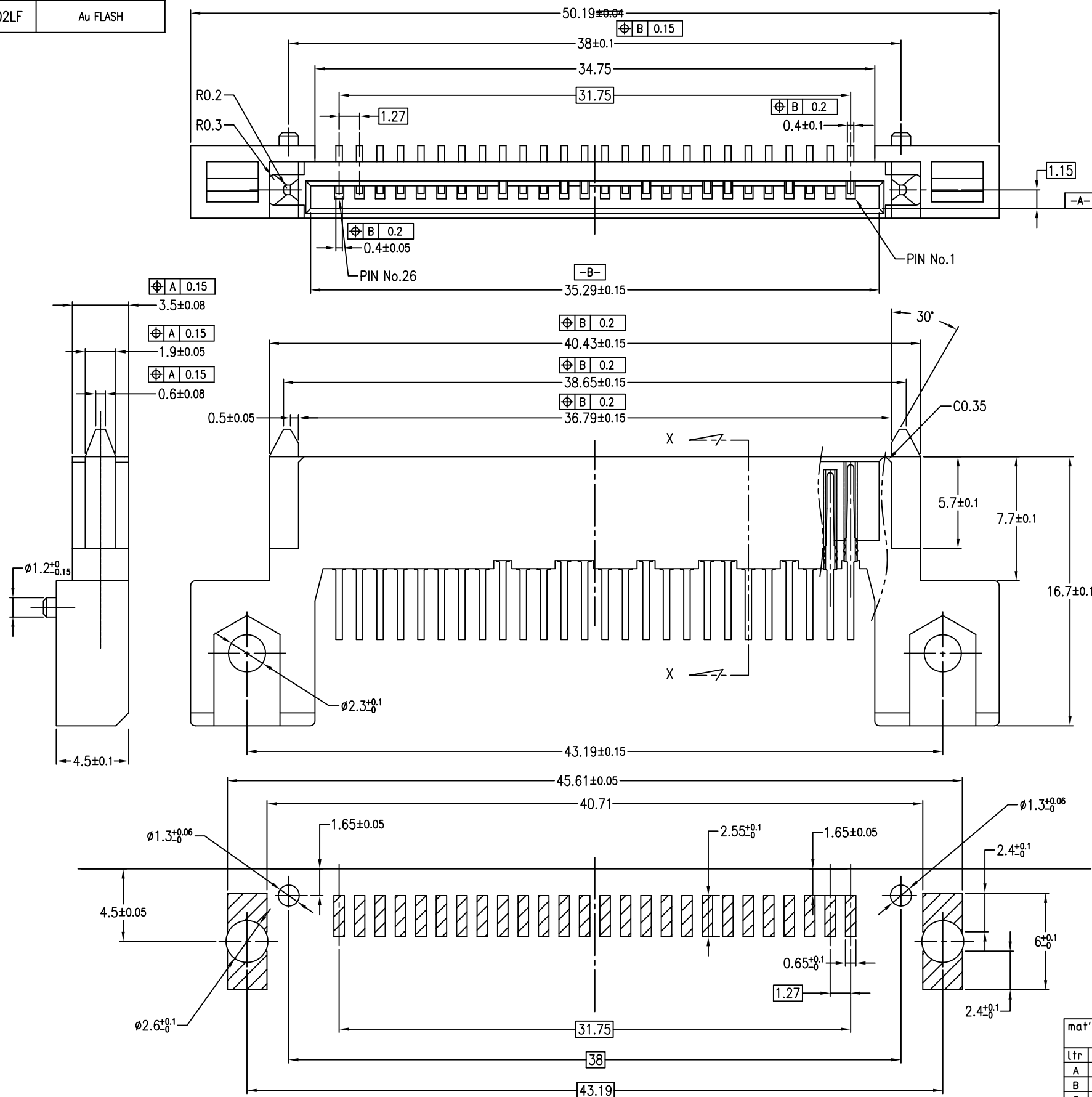


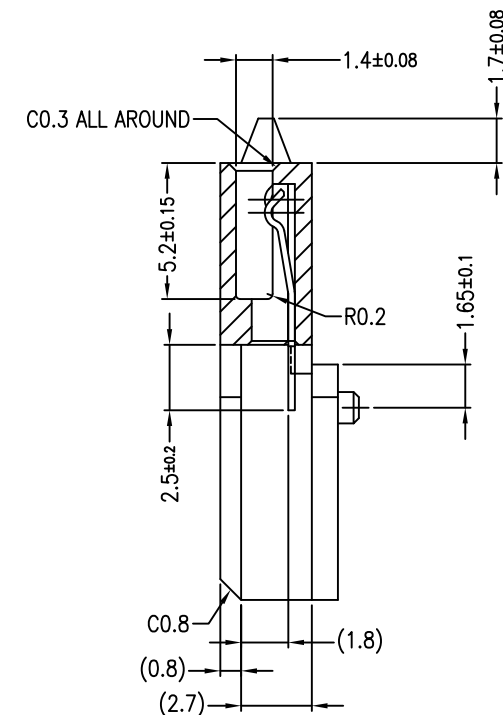
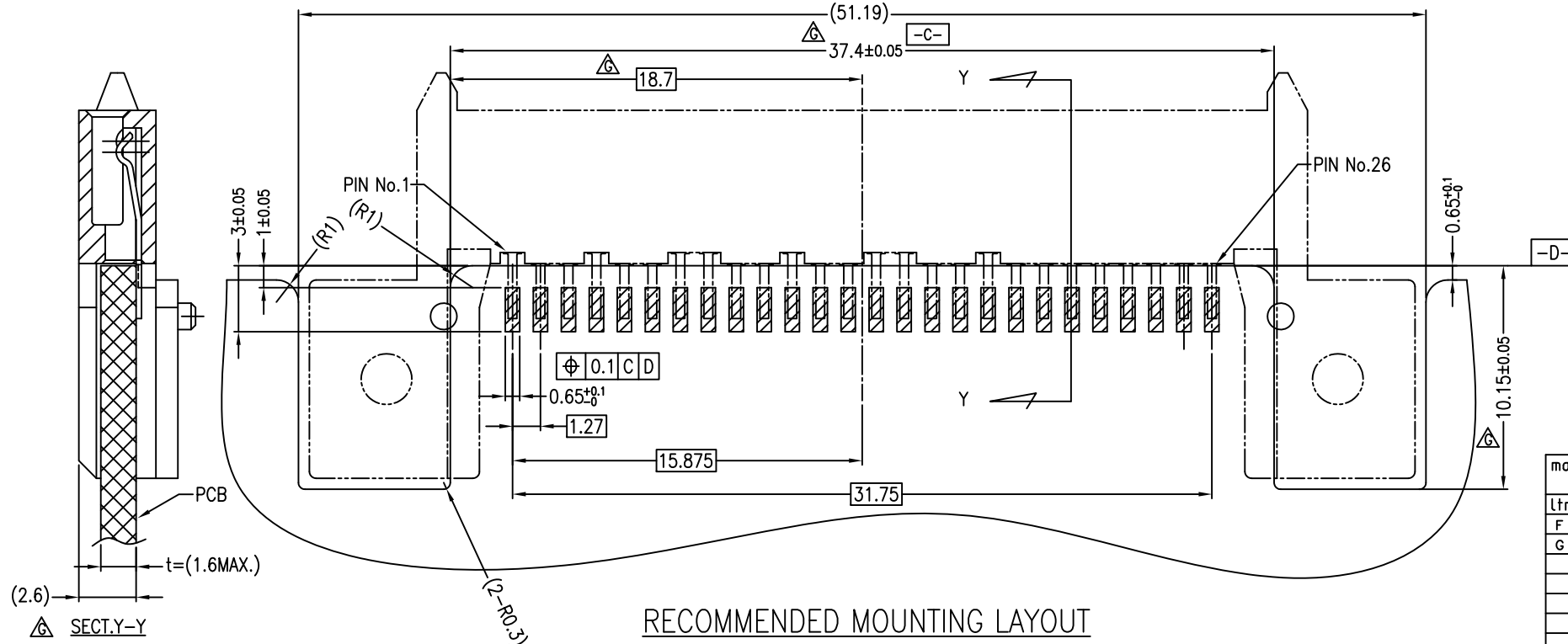
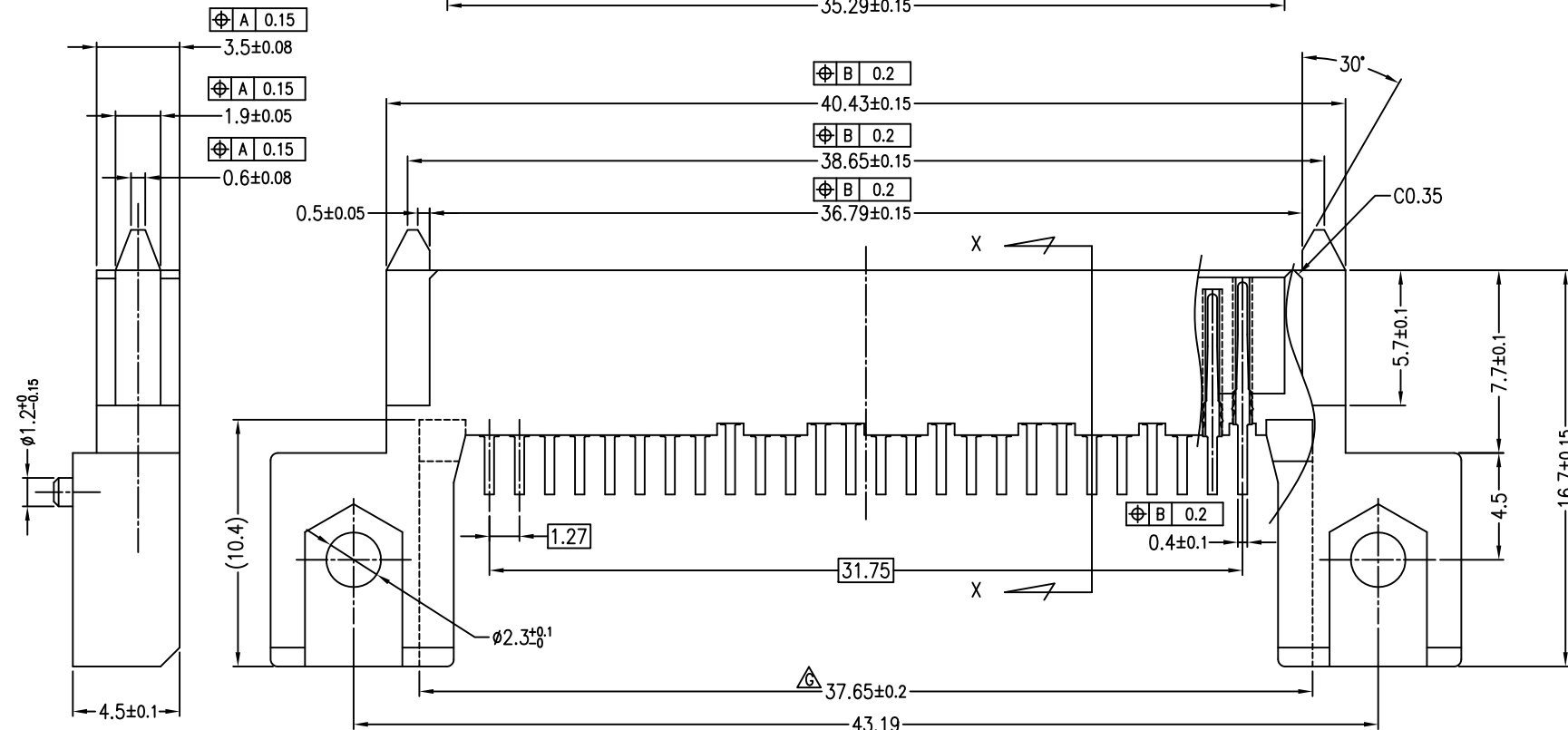
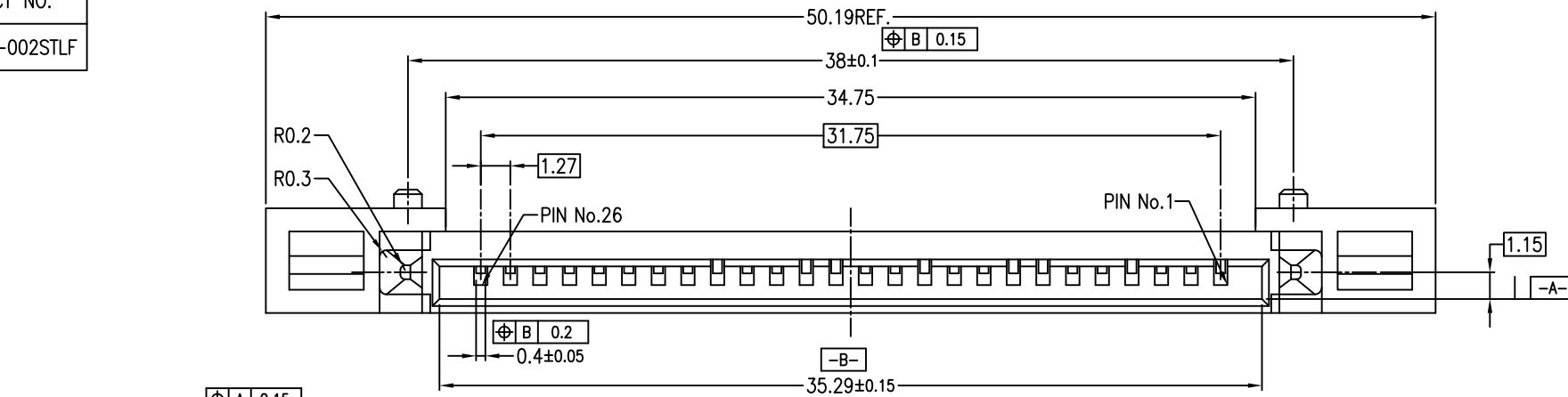
PRODUCT NO.	FINISH : Solder Tail
10033998-001	Pure Sn 1.27μm MIN.
10033998-002	Au FLASH
10033998-002LF	Au FLASH



- NOTE
- THIS PRODUCT MEETS THE iVDR-HWSPEC (2.5-inch, 1.8-inch Serial type)
 - MATERIAL
 - HOUSING : HIGH TEMPERATURE THERMOPLASTIC, BLACK, UL94V-0
 - TERMINAL : COPPER ALLOY
 - FINISH
 - TERMINAL : ALL OVER Ni 1.27μm MIN.
CONTACT POINT Au PLATING 0.3μm MIN.
SOLDER TAIL SEE TABLE
 - RoHS
THIS PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATIONS AS DESCRIBED IN GS-22-008

RECOMMENDED MOUNTING LAYOUT
TOLERANCE UNLESS OTHERWISE: ±0.1

mat'l. code				surface	tolerance	projection	product family	CODE
---				ISO 1302	ISO 406	ISO 1101	53MF	JP
ltr	description	ecn no	dr	date	tolerances unless otherwise specified	angles	linear	MM
A	RELEASED	J04-0286	Y.K	8/23/'04	0.X	±0.3		
B	REVISED	J05-0107	Y.K	2/24/'05	0.XX	±0.3		
C	Change DWG form	J07-0041	Y.K	1/23/'07	0'±2'	0.XXX	±0.3	
D	Change of P/N	J07-0464	Y.K	2007-9-13	dr	Y.KAMEDA	2014-05-16	
E	Change of P/N	J08-0253	Y.K	2008-6-12	enr	Y.KAMEDA	2014-05-16	
F	Add sheet2	J09-0416	Y.K	2008-6-12	chr	M.MINATO	2014-05-16	
G	Change of sheet2	ELX-J-17883	Y.K	2014-05-16	appd	N.SASAME	2014-05-16	
sheet	revision	G	G					
index	sheet	1	2					
				product family	53MF	title	ASSEMBLY	
				dwg no	10033998	sheet 1 of 2	size	A2
				type	Product Customer Drawing	Rev.		
								G

SECT.X-X

NOTE

- 1.THIS PRODUCT MEETS THE iVDR-HWSPEC (2.5-inch, 1.8-inch Serial type)
2.MATERIAL
1) HOUSING : HIGH TEMPERATURE THERMOPLASTIC,BLACK, UL94V-0
2) TERMINAL : COPPER ALLOY
3.FINISH

- 1) TERMINAL : ALL OVER Ni 1.27 μ m MIN.
CONTACT POINT Au PLATING 0.3 μ m MIN.
SOLDER TAIL Au Flash

4.RoHS
THIS PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND OTHER
COUNTRY REGULATIONSAS DESCRIBED IN GS-22-008

[illegible]

RECOMMENDED MOUNTING LAYOUT
TOLERANCE UNLESS OTHERWISE: ± 0.1